## 506311104 10/20/2020

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6357853

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
PETTERI P	11/20/2017
FRANK DAECHE	11/20/2017
ZEESHAN UMAR	09/22/2017
ANDREW SAWLE	11/20/2017
MACIEJ WOJNOWSKI	11/20/2017
XAVER SCHLOEGEL	11/20/2017
JOSEF HOEGLAUER	11/20/2017

## **RECEIVING PARTY DATA**

Name:	INFINEON TECHNOLOGIES AUSTRIA AG
Street Address:	SIEMENSSTRASSE 2
City:	VILLACH
State/Country:	AUSTRIA
Postal Code:	9500

## **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	17074759

## **CORRESPONDENCE DATA**

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ATTORNEY DOCKET NUMBER:	1012-2864/2017P51022 US02	
NAME OF SUBMITTER:	MARK R. BILAK	
SIGNATURE:	/Mark R. Bilak, Reg. No. 47,423/	
DATE SIGNED:	10/20/2020	

506311104 PATENT REEL: 054103 FRAME: 0753

## This document serves as an Oath/Declaration (37 CFR 1.63).

#### **Total Attachments: 12**

source=1012-2864 Declaration and Assignment, signed all#page1.tif source=1012-2864 Declaration and Assignment, signed all#page3.tif source=1012-2864 Declaration and Assignment, signed all#page4.tif source=1012-2864 Declaration and Assignment, signed all#page5.tif source=1012-2864 Declaration and Assignment, signed all#page5.tif source=1012-2864 Declaration and Assignment, signed all#page6.tif source=1012-2864 Declaration and Assignment, signed all#page7.tif source=1012-2864 Declaration and Assignment, signed all#page8.tif source=1012-2864 Declaration and Assignment, signed all#page9.tif source=1012-2864 Declaration and Assignment, signed all#page10.tif source=1012-2864 Declaration and Assignment, signed all#page11.tif source=1012-2864 Declaration and Assignment, signed all#page11.tif source=1012-2864 Declaration and Assignment, signed all#page12.tif

PATENT REEL: 054103 FRAME: 0754

Docket Number: 1012-1932 / 2017P51022 US

# DECLARATION AND ASSIGNMENT FOR PATENT AND DESIGN APPLICATIONS

United States Patent Rights, or United States Plus all Foreign Patent Rights

Power Semiconductor Systems Having Inductor Modules, and Methods of Manufacturing Inductor Modules and Power Semiconductor Systems Having Inductor Modules

As a below named inventor (hereinafter designated as the undersigned), I hereby declare that:

This declaration is directed to the application attached hereto. If the application is not attached hereto, the application is as identified by the attorney docket number as set forth above and/or the following:

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filed on Sep 8, 2017.

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I have reviewed and understand the contents of the above-identified application, including the claims.

I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations § 1.56.

WHEREAS, the undersigned has invented certain at least one claim in the application identified.

WHEREAS, Infineon Technologies Austria AG

of Siemensstrasse 2, 9500 Villach, Austria

its heirs, successors, legal representatives and assigns (hereinafter designated as the Assignee) is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent(s) that may be granted therefor in the United States of America and

in any foreign countries.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, the undersigned has (have) sold, assigned and transferred, and by these considerations does (do) sell, assign and transfer unto said Assignee the full and exclusive right to the said invention in the United States of America, its territories, dependencies and possessions and the entire right, title and interest in and to any and all Letters Patent(s) which may be granted therefor in the United States of America, its territories, dependencies and possessions, and if the box above is designated, in any and all foreign countries; and to any and all divisions, reissues, continuations, conversions and extensions of all of the above for the full term or terms for which the same may be granted.

The undersigned agrees to execute all papers necessary in connection with this application and any continuing, divisional, conversion or reissue applications thereof or any other proceedings before the United States Patent and Trademark Office and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

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The undersigned hereby grants the Assignee's legal representatives the power to insert, before or after this document has been executed by the undersigned, any information to identify the instant patent application which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office,

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Date	Inventor Signature
Full Name of Inventor:	Frank Daeche
Date	Inventor Signature
Full Name of Inventor:	Zeeshan Umar
Date	Inventor Signature
Full Name of Inventor:	Andrew Sawle
Date	Inventor Signature
Full Name of Inventor:	Maciej Wojnowski
Date	Inventor Signature

Full Name of Inventor:	Xaver Schloegel
Date	Inventor Signature
Full Name of Inventor:	Josef Hoeglauer
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Full Name of Inventor:	Andrew Sawle
Date	Inventor Signature
Full Name of Inventor:	Maciej Wojnowski
Date	Inventor Signature

Docket Number: 1012-1932 / 2017P51022 US

Full Name of Inventor:

20,11 2017

Full Name of Inventor:

20-100 2017 Date

Josef Heeglauer

Signature

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<u> 22 0 9 - 36 17</u> Date	Inventor Signature
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Full Name of Inventor: 20/11/2013	Maciej Wojnowski <i> \Q<sub>Ust</sub> \Je∫n∞</i> \
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Page 3 of 3